Description

TPSeal® M2731UV is a Linear Low Density Polyethylene (mLLDPE) with hexene as comonomer.

TPSeal® M2731UV is intended for the manufacture of rotomoulded items and available in natural or in colour, in pellets or in powder.

Main Characteristics

Its specific molecular structure ensures:

- ✓ Excellent impact properties
- ✓ Good dimensional stability
- ✓ Outstanding ESCR
- ✓ UV protected

Application

Designed for the production of technical part with a complex shape and esthetical requirements

Properties

Property	Method	*Unit*	Typical value (*)
Density (**)	ISO 1183	*g/cm³*	**0.927**
Melt Flow Rate *(190°C-2.16kg)*	ISO 1133/D	*g/10min*	**3.5**
Melting Temperature	ISO 11357	*°C*	**117**
Vicat Softening Point *(Method A50)*	ISO 306	*°C*	**112**
Heat Deflection Temperature *(Method B)*	ISO 75	*°C*	**60**
Tensile modulus	ISO 527	*MPa*	**400**
Tensile strength @yield	ISO 527	*MPa*	**14**
ESCR *(10% Igepal)*	ASTM D1693	h (F50)	**> 1000**

(*) Data not intended for specification purposes *(**) Based on natural resin*

Processing conditions

It is recommended to keep product dry prior use for production.

Handling and storage

Please refer to the material safety data sheet (MSDS) for handling and storage information. It is advisable to convert the product within one year after delivery provided storage conditions are used as given in the MSDS of our product.
MSDS may be obtained from the website: http://www.polymers.total.com/

Specialty Compound

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